## **GP1S34**

#### **■** Features

1. Ultra-compact package

2. PWB mounting type

3. High sensing accuracy (Slit width: 0.1mm)

4. With a mounting hole

### ■ Applications

1. Cameras

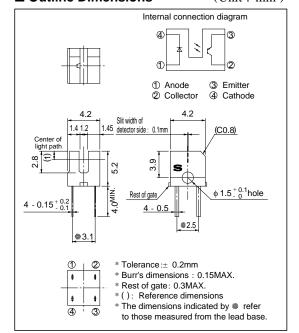
2. Floppy disk drives

3. Handy scanners

# Subminiature, High Sensing Accuracy Photointerrupter

**■** Outline Dimensions

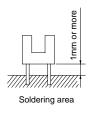
(Unit: mm)



## **■** Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$ 

	Parameter	Symbol	Rating	Unit	
Input	Forward current	$I_{\mathrm{F}}$	50	mA	
	Reverse voltage	VR	6	V	
	Power dissipation	P	75	mW	
Output	Collector-emitter voltage	V <sub>CEO</sub>	35	V	
	Emitter-collector voltage	V <sub>ECO</sub>	6	V	
	Collector current	$I_{C}$	20	mA	
	Collector power dissipation	Pc	75	mW	
	Total power dissipation	P <sub>tot</sub>	100	mW	
Operating temperature		T <sub>opr</sub>	- 25 to + 85	°C	
Storage temperature		T stg	- 40 to + 100	°C	
	*1Soldering temperature	T <sub>sol</sub>	260	°C	



<sup>\*1</sup> For 5 seconds

<sup>&</sup>quot; In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that occur in equipment using any of SHARP's devices, shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest version of the device specification sheets before using any SHARP's device."

## **■** Electro-optical Characteristics

 $(Ta = 25^{\circ}C)$ 

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		VF	$I_F=20mA \\$	-	1.2	1.4	V
	Reverse current		$I_R$	$V_R = 3V$	-	-	10	μΑ
Output	Collector dark current		ICEO	$V_{\text{CE}} = 20V$	-	-	100	nA
Transfer characteristics	Collector current		Ic	$V_{CE} = 5V$ , $I_F = 5mA$	80	-	320	μΑ
	Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	$I_F = 10 \text{mA}, I_C = 50 \mu \text{ A}$	-	-	0.4	V
	Response time	Rise time	$t_{\rm r}$	$V_{CE} = 5V$ , $I_{C} = 100 \mu A$	-	50	150	μs
		Fall time	$t_{\mathrm{f}}$	$R_L=1~000~\Omega$	-	50	150	μs

Fig. 1 Forward Current vs. Ambient Temperature

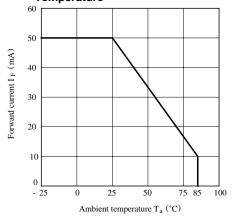


Fig. 3 Forward Current vs. Forward Voltage

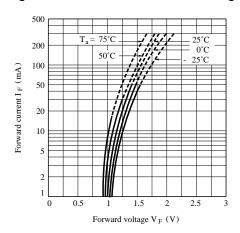


Fig. 2 Power Dissipation vs. Ambient Temperature

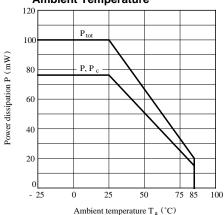


Fig. 4 Collector Current vs.
Forward Current

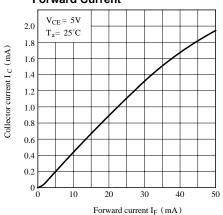




Fig. 5 Collector Current vs.
Collector-emitter Voltage

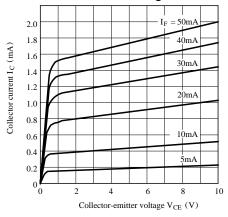


Fig. 7 Collector-emitter Saturation Voltage vs. Ambient Temperature

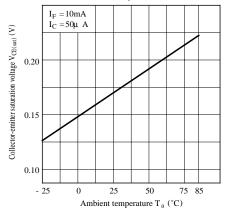


Fig. 9 Response Time vs. Load Resistance

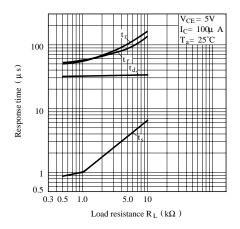


Fig. 6 Collector Current vs.
Ambient Temperature

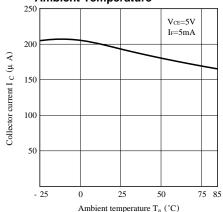
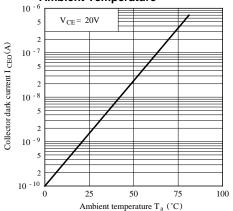


Fig. 8 Collector Dark Current vs.
Ambient Temperature



#### **Test Circuit for Response Time**

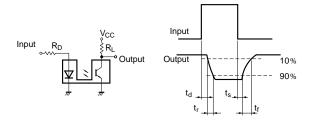
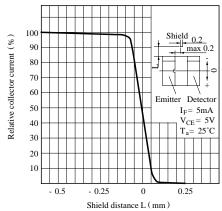
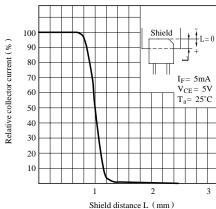


Fig.10 Relative Collector Current vs. Shield Distance (1)



 $\bullet\,$  Please refer to the chapter "Precautions for Use".

Fig.11 Relative Collector Current vs. Shield Distance (2)



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  - Gas leakage sensor breakers
  - Alarm equipment
  - Various safety devices, etc.
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